

臺日合作需求調查表

*請盡可能以日語或英語填寫。

 (此區可放公司 LOGO)		(企業名稱_中文)均華精密工業股份有限公司			
		(企業名稱_ Gallant Micro. Machining Co., Ltd.)			
所在地Location	No. 2-1, Minsheng St., Tucheng Dist., New Taipei City, 236044, Taiwan				
ウェブサイトWebsite	http://www.gmmcorp.com.tw/	T E L	02-22682216		
企業情報 Company Information	設立年度 Foundation	2010	連絡担 当者	担当者氏名 Name	石總秘書:陳育慈#03-560-1222#5717 協會窗口:曾幸凰
	従業員数Employee	405		役職 Position	
	資本金Capital	US\$ 27,484,325		E-mail	陳育慈 akichen@gmmcorp.com.tw 曾幸凰 clare@gmmcorp.com.tw
	海外取引実績	無 <input type="checkbox"/> 有 <input checked="" type="checkbox"/>		電話/携帯	石總秘書:陳育慈#03-560-1222#5717 協會窗口:曾幸凰#02-22682216#2026
主要事業及び生産分野 Major business	Semiconductor molds and packaging equipment The company's core technology and related main products include precision pick-and-place technology for chip sorter machines and die-bonding machines; precision processing technology for punching forming machines and automatic sealing machines; photoelectric integration technology for laser marking machines and optical inspection machines, etc.				
当社の強み Company Strength	GMM Die Sorter and Die Bonder are key solutions driving excellence in Advanced Packaging Technology. When integrated with high-precision AOI inspections capabilities, they drive superior productivity, process consistency and meeting the rising demand for high-quality production in the advanced packaging industry.				
生產品又は生産ライン Phots. Of Product, Production line	Advanced Packaging Technology High-Precision AOI Inspection Die Sorter/Pick and Place Die Bonder/Die Attach EFEM Automation Others				
主要取引実績 Major trading partner	Leading companies in semiconductor				
商談を希望する分野 Desirable business field with Taiwan	Main products include precision pick-and-place technology for chip sorter machines and die-bonding machines; precision processing technology for punching forming machines and automatic sealing machines; photoelectric integration technology for laser marking machines and optical inspection machines, etc. Advanced Packaging Technology High-Precision AOI Inspection Die Sorter/Pick and Place Die Bonder/Die Attach EFEM Automation Others				

<p>希望する商談内容 Desirable business with Taiwan ※為增加媒合洽談匹配精 準度・請盡可能具體填寫 希望洽談的內容</p>	<p>○を付けて下さい <input checked="" type="checkbox"/>販売：Advanced Packaging Technology High-Precision AOI Inspection Die Sorter/Pick and Place Die Bonder/Die Attach EFEM Automation <input type="checkbox"/>購入： <input type="checkbox"/>技術提携： <input type="checkbox"/>共同で第三国展開共同で第三国展開・作業委託・その他() 具体的商談内容：</p>
<p>媒合會預計使用言語</p>	<p><input type="checkbox"/>日本語 <input checked="" type="checkbox"/>英語 如需日文口譯員・請備註：請安排日文口譯員</p>

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